MC68HC11A8 MC68HC11A1 MC68HC11A0

Technical Summary 8-Bit Microcontrollers

SEMICONDUCTOR

TECHNICAL DATA

1 Introduction

MOTOROLA

The MC68HC11A8, MC68HC11A1, and MC68HC11A0 high-performance microcontroller units (MCUs) are based on the M68HC11 Family. These high speed, low power consumption chips have multiplexed buses and a fully static design. The chips can operate at frequencies from 3 MHz to dc. The three MCUs are created from the same masks; the only differences are the value stored in the CONFIG register, and whether or not the ROM or EEPROM is tested and guaranteed.

COM-CI For detailed information about specific characteristics of these MCUs, refer to the M68HC11 Reference Manual (M68HC11RM/AD).

1.1 Features

- M68HC11 CPU
- Power Saving STOP and WAIT Modes
- 8 Kbytes ROM
- 512 Bytes of On-Chip EEPROM
- 256 Bytes of On-Chip RAM (All Saved During Standby)
- 16-Bit Timer System
 - 3 Input Capture Channels
 - 5 Output Compare Channels
- 8-Bit Pulse Accumulator
- Real-Time Interrupt Circuit
- Computer Operating Properly (COP) Watchdog System
- Synchronous Serial Peripheral Interface (SPI)
- Asynchronous Nonreturn to Zero (NRZ) Serial Communications Interface (SCI)
- 8-Channel, 8-Bit Analog-to-Digital (A/D) Converter
- 38 General-Purpose Input/Output (I/O) Pins
 - 15 Bidirectional I/O Pins
 - 11 Input-Only Pins and 12 Output-Only Pins (Eight Output-Only Pins in 48-Pin Package)
- Available in 48-Pin Dual In-Line Package (DIP) or 52-Pin Plastic Leaded Chip Carrier (PLCC)

This document contains information on a new product. Specifications and information herein are subject to change without notice.



Table 1 MC68HC11Ax Family Members

Device Number	ROM	EEPROM	RAM	CONFIG*	Comments
MC68HC11A8	8K	8K 512 256 \$0F Family built around this of		Family built around this device	
MC68HC11A1	0	512	256	\$0D	ROM disabled
MC68HC11A0	0	0	0 256 \$0C ROM and EEPROM disa		ROM and EEPROM disabled

Table 2 Ordering Information

Package	Temperature	CONFIG	Description	MC Order Number
48-Pin Plastic DIP	–40°to + 85°C	\$0F	BUFFALO ROM	MC68HC11A8P1
(P suffix)	-40°to + 85°C	\$0D	No ROM	MC68HC11A1P
	–40°to + 105°C	\$0D	No ROM	MC68HC11A1VP
	–40°to + 125°C	\$0D	No ROM	MC68HC11A1MP
	-40°to + 85°C	\$09	No ROM, COP On	MC68HCP11A1P
	–40°to + 105°C	\$09	No ROM, COP On	MC68HCP11A1VP
	–40°to + 125°C	\$09	No ROM, COP On	MC68HCP11A1MP
	–40°to + 85°C	\$0C	No ROM, No EEPROM	MC68HC11A0P
		•	A JA M	

52-Pin PLCC	-40°to + 85°C	\$0F		BUFFALO ROM	MC68HC11A8FN1
(FN suffix)	-40°to + 85°C	\$	0D 🦡 🖇	No ROM	MC68HC11A1FN
	_40°to + 105°C	\$	0D	No ROM	MC68HC11A1VFN
	-40°to + 125°C	\$	0D	No ROM	MC68HC11A1MFN
	-40°to + 85°C	\$	09	No ROM, COP On	MC68HCP11A1FN
	-40°to + 105°C	\$	09	No ROM, COP On	MC68HCP11A1VFN
	–40°to + 125°C	\$	09	No ROM, COP On	MC68HCP11A1MFN
	-40°to + 85°C	\$	0C	No ROM, No EEPROM	MC68HC11A0FN
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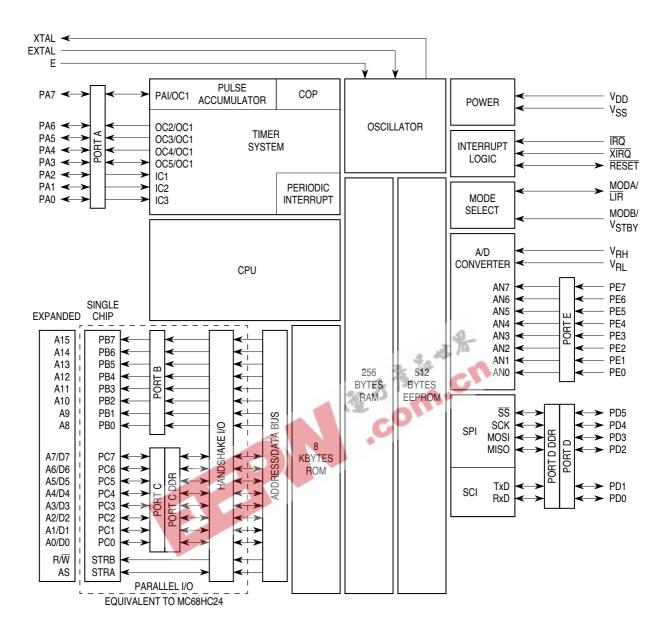
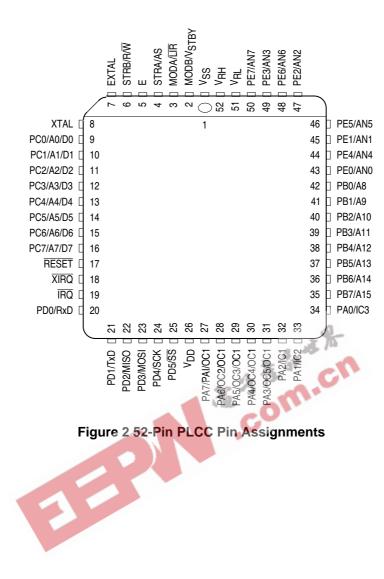


Figure 1 MC68HC11A8 Block Diagram

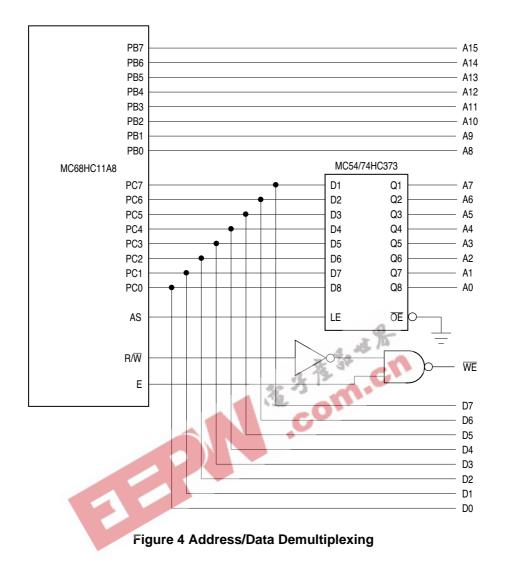




2 Operating Modes and Memory Maps

In single-chip operating mode, the MC68HC11A8 is a monolithic microcontroller without external address or data buses.

In expanded multiplexed operating mode, the MCU can access a 64 Kbyte address space. The space includes the same on-chip memory addresses used for single-chip mode plus external peripheral and memory devices. The expansion bus is made up of ports B and C and control signals AS and R/W. The address, R/W, and AS signals are active and valid for all bus cycles including accesses to internal memory locations. The following figure illustrates a recommended method of demultiplexing low-order addresses from data at port C.



Special bootstrap mode allows special purpose programs to be entered into internal RAM. The bootloader program uses the SCI to read a 256-byte program into on-chip RAM at \$0000 through \$00FF. After receiving the character for address \$00FF, control passes to the loaded program at \$0000.

Special test mode is used primarily for factory testing.

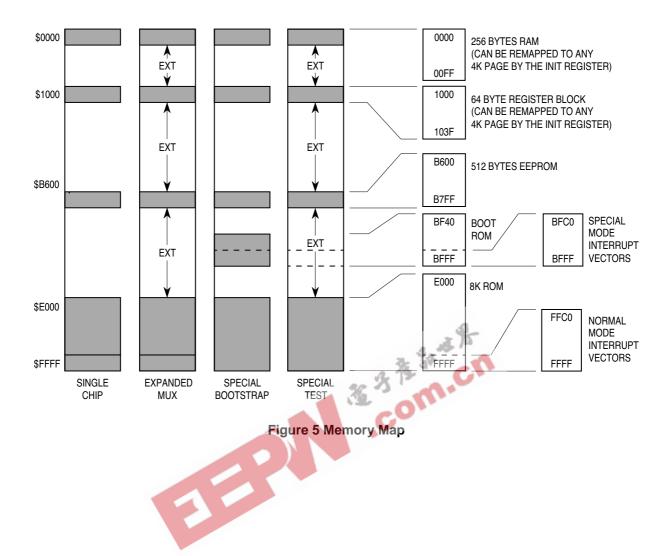
2.1 Memory Maps

Memory locations are the same for expanded multiplexed and single-chip modes. The on-board 256byte RAM is initially located at \$0000 after reset. The 64-byte register block originates at \$1000 after reset. RAM and/or the register block can be placed at any other 4K boundary (\$x000) after reset by writing an appropriate value to the INIT register. The 512-byte EEPROM is located at \$B600 through \$B7FF after reset if it is enabled. The 8 Kbyte ROM is located at \$E000 through \$FFFF if it is enabled.

Hardware priority is built into the memory remapping. Registers have priority over RAM, and RAM has priority over ROM. The higher priority resource covers the lower, making the underlying locations inaccessible.

In special bootstrap mode, a bootloader ROM is enabled at locations \$BF40 through \$BFFF.

In special test and special bootstrap modes, reset and interrupt vectors are located at \$BFC0 through \$BFFF.



	Bit 7	6	5	4	3	2	1	Bit 0	
\$1000	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0	PORTA
\$1001									Reserved
\$1002	STAF	STAI	CWOM	HNDS	OIN	PLS	EGA	INVB	PIOC
\$1003	PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0	PORTC
\$1004	PB7	PB6	PB5	PB4	PB3	PB2	PB1	PB0	PORTB
\$1005	PCL7	PCL6	PCL5	PCL4	PCL3	PCL2	PCL1	PCL0	PORTCL
\$1006									Reserved
\$1007	DDC7	DDC6	DDC5	DDC4	DDC3	DDC2	DDC1	DDC0	DDRC
\$1008	0	0	PD5	PD4	PD3	PD2	PD1	PD0	PORTD
\$1009	0	0	DDD5	DDD4	DDD3	DDD2	DDD1	DDD0	DDRD
\$100A	PE7	PE6	PE5	PE4	PE3	PE2	PE1	PE0	PORTE
\$100B	FOC1	FOC2	FOC3	FOC4	FOC5	0	4 _0	0	CFORC
\$100C	OC1M7	OC1M6	OC1M5	OC1M4	OC1M3	0	0	0	OC1M
\$100D	OC1D7	OC1D6	OC1D5	OC1D4	OC1D3	0	0	0	OC1D
\$100E	Bit 15	14	13	12	11	10	9	Bit 8	TCNT (High)
\$100F	Bit 7	6	5	4	3	2	1	Bit 0	TCNT (Low)
\$1010	Bit 15	14	13	12	11	10	9	Bit 8	TIC1 (High)
\$1011	Bit 7	6	5	4	3	2	1	Bit 0	TIC1 (Low)
\$1012	Bit 15	14	13	12	11	10	9	Bit 8	TIC2 (High)
\$1013	Bit 7	6	5	4	3	2	1	Bit 0	TIC2 (Low)
\$1014	Bit 15	14	13	12	11	10	9	Bit 8	TIC3 (High)
\$1015	Bit 7	6	5	4	3	2	1	Bit 0	TIC3 (Low)
\$1016	Bit 15	14	13	12	11	10	9	Bit 8	TOC1(High)
\$1017	Bit 7	6	5	4	3	2	1	Bit 0	TOC1 (Low)
\$1018	Bit 15	14	13	12	11	10	9	Bit 8	TOC2 (High)
\$1019	Bit 7	6	5	4	3	2	1	Bit 0	TOC2 (Low)
\$101A	Bit 15	14	13	12	11	10	9	Bit 8	TOC3 (High)
\$101B	Bit 7	6	5	4	3	2	1	Bit 0	TOC3 (Low)
\$101C	Bit 15	14	13	12	11	10	9	Bit 8	TOC4 (High)
\$101D	Bit 7	6	5	4	3	2	1	Bit 0	TOC4 (Low)
\$101E	Bit 15	14	13	12	11	10	9	Bit 8	TOC5 (High)
\$101F	Bit 7	6	5	4	3	2	1	Bit 0	TOC5 (Low)
\$1020	OM2	OL2	OM3	OL3	OM4	OL4	OM5	OL5	TCTL1
\$1021	0	0	EDG1B	EDG1A	EDG2B	EDG2A	EDG3B	EDG3A	TCTL2
\$1022	OC1I	OC2I	OC3I	OC4I	OC5I	IC1I	IC2I	IC3I	TMSK1
\$1023	OC1F	OC2F	OC3F	OC4F	OC5F	IC1F	IC2F	IC3F	TFLG1
\$1024	ΤΟΙ	RTII	PAOVI	PAII	0	0	PR1	PR0	TMSK2
\$1025	TOF	RTIF	PAOVF	PAIF	0	0	0	0	TFLG2

Table 3 MC68HC11A8 Register and Control Bit Assignments (Sheet 1 of 2)

(The register block can be remapped to any 4K boundary.)

	Bit 7	6	5	4	3	2	1	Bit 0	
\$1026	DDRA7	PAEN	PAMOD	PEDGE	0	0	RTR1	RTR0	PACTL
\$1027	Bit 7	6	5	4	3	2	1	Bit 0	PACNT
\$1028	SPIE	SPE	DWOM	MSTR	CPOL	CPHA	SPR1	SPR0	SPCR
\$1029	SPIF	WCOL	0	MODF	0	0	0	0	SPSR
\$102A	Bit 7	6	5	4	3	2	1	Bit 0	SPDR
\$102B	TCLR	0	SCP1	SCP0	RCKB	SCR2	SCR1	SCR0	BAUD
\$102C	R8	Т8	0	М	WAKE	0	0	0	SCCR1
\$102D	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK	SCCR2
\$102E	TDRE	тс	RDRF	IDLE	OR	NF	FE	0	SCSR
\$102F	R7/T7	R6/T6	R5/T5	R4/T4	R3/T3	R2/T2	R1/T1	R0/T0	SCDR
\$1030	CCF	0	SCAN	MULT	CD	CC	СВ	CA	ADCTL
\$1031	Bit 7	6	5	4	3	2	1	Bit 0	ADR1
\$1032	Bit 7	6	5	4	3	2	1	Bit 0	ADR2
\$1033	Bit 7	6	5	4	3	2	1	Bit 0	ADR3
\$1034	Bit 7	6	5	4	3 3	2		Bit 0	ADR4
\$1035					132	on			Reserved
\$1038					C				Reserved
\$1039	ADPU	CSEL	IRQE	DLY	CME	0	CR1	CR0	OPTION
\$103A	Bit 7	6	5	4	3	2	1	Bit 0	COPRST
\$103B	ODD	EVEN	0	BYTE	ROW	ERASE	EELAT	EEPGM	PPROG
\$103C	RBOOT	SMOD	MDA	IRV	PSEL3	PSEL2	PSEL1	PSEL0	HPRIO
\$103D	RAM3	RAM2	RAM1	RAM0	REG3	REG2	REG1	REG0	INIT
\$103E	TILOP	0	OCCR	CBYP	DISR	FCM	FCOP	TCON	TEST1
\$103F	0	0	0	0	NOSEC	NOCOP	ROMON	EEON	CONFIG

Table 3 MC68HC11A8 Register and Control Bit Assignments (Sheet 2 of 2)

(The register block can be remapped to any 4K boundary.)

HPRIO — Highest Priority I-Bit Interrupt and Miscellaneous								\$103C	
	Bit 7	6	5	4	3	2	1	Bit 0	
	RBOOT	SMOD	MDA	IRV	PSEL3	PSEL2	PSEL1	PSEL0	
RESET:					0	1	0	1	

RBOOT, SMOD, and MDA reset depend on conditions at reset and can only be written in special modes (SMOD = 1).

RBOOT — Read Bootstrap ROM

0 = Bootloader ROM disabled and not in map

- 1 = Bootloader ROM enabled and in map at \$BF40-\$BFFF
- SMOD Special Mode Select

MDA — Mode Select A

Inputs		Mode	Latched at Reset			
MODB	MODA		RBOOT	SMOD	MDA	
1	0	Single Chip	0	0	0	
1	1	Expanded Multiplexed	-0	0	1	
0	0	Special Bootstrap	a 1 🔥	1	0	
0	1	Special Test	0	1	1	

IRV — Internal Read Visibility

0 = No internal read visibility on external bus

1 = Data from internal reads is driven out through the external data bus

PSEL3–PSEL0 — Priority Select Bits 3 through 0 Refer to 3 Resets and Interrupts.

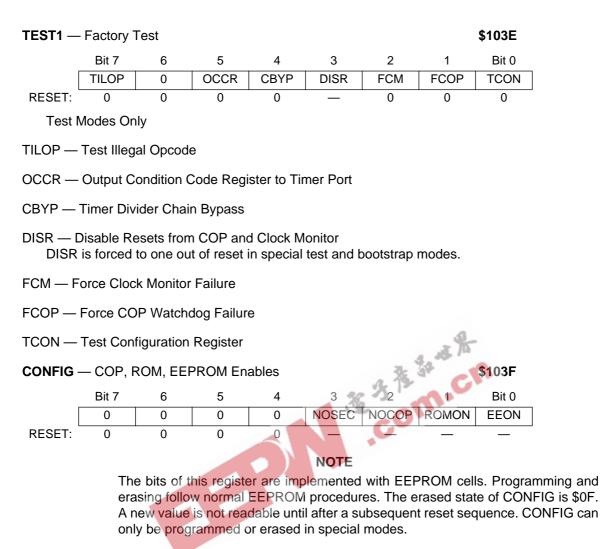
INIT — RAM and I/O Mapping \$								
	Bit 7	6	5	4	3	2	1	Bit 0
	RAM3	RAM2	RAM1	RAM0	REG3	REG2	REG1	REG0
RESET:	0	0	0	0	0	0	0	1

RAM[3:0] —256-Byte Internal RAM Map Position

RAM[3:0] determine the upper four bits of the RAM address, positioning RAM at the selected 4K boundary.

REG[3:0] —64-Byte Register Block Map Position

REG[3:0] determine the upper four bits of the register address, positioning registers at the selected 4K boundary. Register can be written only once in the first 64 cycles out of reset in normal modes, or any time in special modes.



NOSEC — EEPROM Security Disable

Refer to 4 Electrically Erasable Programmable Read-Only Memory (EEPROM).

NOCOP — COP System Disable

Refer to 3 Resets and Interrupts.

ROMON — ROM Enable

In single-chip mode, ROMON is forced to one out of reset.

- 0 = 8K ROM removed from the memory map
- 1 = 8K ROM present in the memory map

EEON — EEPROM Enable

- 0 = EEPROM is removed from the memory map
- 1 = EEPROM is present in the memory map

3 Resets and Interrupts

The MC68HC11A8 has three reset vectors and 18 interrupt vectors. The reset vectors are as follows:

- RESET, or Power-On
- COP Clock Monitor Fail
- COP Failure

The eight interrupt vectors service 23 interrupt sources (three non-maskable, 20 maskable). The three non-maskable interrupt vectors are as follows:

- Illegal Opcode Trap
- Software Interrupt
- XIRQ Pin (Pseudo Non-Maskable Interrupt)

The 20 maskable interrupt sources are subject to masking by a global interrupt mask, the I bit in the condition code register (CCR). In addition to the global I bit, all of these sources except the external interrupt (\overline{IRQ}) pin are controlled by local enable bits in control registers. Most interrupt sources in the M68HC11 have separate interrupt vectors. For this reason, there is usually no need for software to poll control registers to determine the cause of an interrupt. The maskable interrupt sources respond to a fixed priority relationship, except that any one source can be dynamically elevated to the highest priority position of any maskable source. Refer to the table of interrupt and reset vector assignments.

On-chip peripheral systems generate maskable interrupts that are recognized only if the I bit in the CCR is clear. Maskable interrupts are prioritized according to a default arrangement, but any one source can be elevated to the highest maskable priority position by the HPRIO register. The HPRIO register can be written at any time, provided the I bit in the CCR is set.

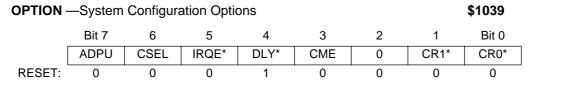
For some interrupt sources, such as the parallel I/O and SCI interrupts, the flags are automatically cleared during the course of responding to the interrupt requests. For example, the RDRF flag in the SCI system is cleared by the automatic clearing mechanism, which consists of a read of the SCI status register while RDRF is set, followed by a read of the SCI data register. The normal response to an RDRF interrupt request is to read the SCI status register to check for receive errors, then to read the received data from the SCI data register. These two steps satisfy the automatic clearing mechanism without requiring any special instructions.

The real-time interrupt (RTI) function generates hardware interrupts at a fixed periodic rate. These hardware interrupts provide a time reference signal for routines that measure real time. The routine notes the number of times a particular interrupt has occurred and multiplies that number by the predetermined subroutine execution time.

There are four RTI signal rates available in the MC68HC11A8. The MCU oscillator frequency and the value of two software-accessible control bits, RTR1 and RTR0, in the pulse accumulator control register (PACTL) determine these signal rates. Refer to **8 Main Timer** for more information about PACTL.

Vector Address	Interrupt Source	CCR Mask	Local Mask
FFC0, C1 – FFD4, D5	Reserved	_	_
FFD6, D7	SCI Serial System	I Bit	
	SCI Transmit Complete		TCIE
	SCI Transmit Data Register Empty	-	TIE
	SCI Idle Line Detect	-	ILIE
	SCI Receiver Overrun		RIE
	SCI Receive Data Register Full		RIE
FFD8, D9	SPI Serial Transfer Complete	I Bit	SPIE
FFDA, DB	Pulse Accumulator Input Edge	I Bit	PAII
FFDC, DD	Pulse Accumulator Overflow	I Bit	PAOVI
FFDE, DF	Timer Overflow	I Bit	TOI
FFE0, E1	Timer Input Capture 4/Output Compare 5	I Bit	14051
FFE3, E2	Timer Output Compare 4	I Bit	OC4I
FFE4, E5	Timer Output Compare 3	I Bit	OC3I
FFE6, E7	Timer Output Compare 2	I Bit	OC2I
FFE8, E9	Timer Output Compare 1	I Bit	OC1I
FFEA, EB	Timer Input Capture 3	I Bit	IC3
FFEC, ED	Timer Input Capture 2	I Bit	IC2I
FFEE, EF	Timer Input Capture 1	I Bit	IC1I
FFF0, F1	Real-Time Interrupt	I Bit	RTII
FFF2, F3	Parallel I/O Handshake	I Bit	STAI
	IRQ	-	None
FFF4, F5	XIRQ Pin	X Bit	None
FFF6, F7	Software Interrupt	None	None
FFF8, F9	Illegal Opcode Trap	None	None
FFFA, FB	COP Failure	None	NOCOP
FFFC, FD	COP Clock Monitor Fail	None	CME
FFFE, FF	RESET	None	None

Table 4 Interrupt and Reset Vector Assignments



*Can be written only once in first 64 cycles out of reset in normal modes, or any time in special modes.

ADPU —A/D Converter Power-up Refer to **10 Analog-to-Digital Converter**.

CSEL —Clock Select Refer to **10 Analog-to-Digital Converter**.

IRQE — IRQ Select Edge-Sensitive Only

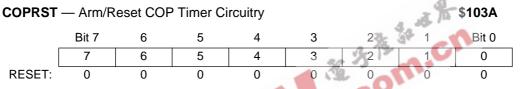
0 = Low logic level recognition

1 = Falling edge recognition

- DLY Enable Oscillator Start-Up Delay on Exit from STOP
 - 0 = No stabilization delay on exit from STOP
 - 1 = Stabilization delay enabled on exit from STOP
- CME Clock Monitor Enable
 - 0 = Clock monitor disabled; slow clocks can be used
 - 1 = Slow or stopped clocks cause clock failure reset

CR1, CR0 — COP Timer Rate Select

CR [1:0]	Divide E/2 ¹⁵ By	XTAL = 4.0 Mhz Timeout –0/+32.8 ms	XTAL = 8.0 MHz Timeout -0/+16.4 ms	XTAL = 12.0 MHz Timeout –0/+10.9 ms	
0 0	1	32.768 ms	16.384 ms	10.923 ms	
0 1	4	131.072 ms	65.536 ms	43.691 ms	
1 0	16	524.288 ms	262.140 ms	174.76 ms	
11	64	2.097 sec	1.049 sec	699.05 ms	
	E =	1.0 MHz	2.0 MHz	3.0 MHz	



Write \$55 to COPRST to arm COP watchdog clearing mechanism. Write \$AA to COPRST to reset COP watchdog.

\$103C

HPRIO — Highest Priority I-Bit Interrupt and Miscellaneous

	Bit 7	6	5	4	3	2	1	Bit 0
	RBOOT	SMOD	MDA	IRV	PSEL3	PSEL2	PSEL1	PSEL0
RESET:					0	1	0	1

RBOOT — Read Bootstrap ROM Bits 7–4 Refer to **2 Operating Modes and Memory Maps**.

SMOD — Special Mode Select

Refer to 2 Operating Modes and Memory Maps.

MDA — Mode Select A

Refer to 2 Operating Modes and Memory Maps.

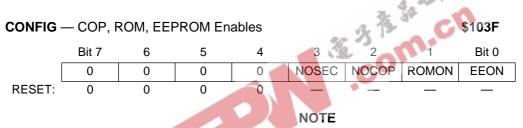
IRV — Internal Read Visibility

Refer to 2 Operating Modes and Memory Maps.

PSEL[3:0] — Priority Select Bits 3 through 0

Can be written only while the I bit in the CCR is set (interrupts disabled). These bits select one interrupt source to be elevated above all other I-bit related sources.

PSEL[3:0]	Interrupt Source Promoted
0000	Timer Overflow
0001	Pulse Accumulator Overflow
0010	Pulse Accumulator Input Edge
0011	SPI Serial Transfer Complete
0100	SCI Serial System
0101	Reserved (Default to IRQ)
0110	ĪRQ
0111	Real-Time Interrupt
1000	Timer Input Capture 1
1001	Timer Input Capture 2
1010	Timer Input Capture 3
1011	Timer Output Compare 1
1100	Timer Output Compare 2
1101	Timer Output Compare 3
1110	Timer Output Compare 4
1111	Timer Output Compare 5



The bits of this register are implemented with EEPROM cells. Programming and erasing follow normal EEPROM procedures. The erased state of CONFIG is \$0F. A new value is not readable until after a subsequent reset sequence. CONFIG can only be programmed or erased in special modes.

NOSEC — EEPROM Security Disable Refer to **4 Electrically Erasable Programmable Read-Only Memory (EEPROM)**.

- NOCOP COP system disable
 - 0 = COP enabled (forces reset on timeout)
 - 1 = COP disabled (does not force reset on timeout)

ROMON — ROM Enable

Refer to 2 Operating Modes and Memory Maps.

EEON — EEPROM Enable

Refer to 2 Operating Modes and Memory Maps.

4 Electrically Erasable Programmable Read-Only Memory (EEPROM)

The 512 bytes of EEPROM in the MC68HC11A8 are located at \$B600 through \$B7FF. The EEON bit in CONFIG controls the presence or absence of the EEPROM in the memory map. When EEON = 1 (erased state), the EEPROM is enabled. When EEON = 0, the EEPROM is disabled and out of the memory map. EEON is reset to the value last programmed into CONFIG. An on-chip charge pump develops the high voltage required for programming and erasing. When the E clock is less than 1 MHz, select an internal clock. This drives the EEPROM charge pump by writing a one to the CSEL bit in the OPTION register.

The PPROG register controls the programming and erasing of the EEPROM. To erase the EEPROM, complete the following steps using the PPROG register:

- 1. Write to PPROG with the ERASE, EELAT, and appropriate BYTE and ROW bits set.
- 2. Write to the appropriate EEPROM address with any data. Row erase only requires a write to any location in the row. Bulk erase is accomplished by writing to any location in the array.
- 3. Write to PPROG with ERASE, EELAT, EEPGM, and the appropriate BYTE and ROW bits set.
- 4. Delay for 10 ms or more, as appropriate.
- 5. Clear the EEPGM bit in PPROG to turn off the high voltage.
- 6. Clear the PPROG register to reconfigure the EEPROM address and data buses for normal operation.

To program the EEPROM, complete the following steps using the PPROG register:

- 1. Write to PPROG with the EELAT bit set.
- 2. Write data to the desired address.
- 3. Write to PPROG with the EELAT and EEPGM bits set.
- 4. Delay for 10 ms or more, as appropriate.
- 5. Clear the EEPGM bit in PPROG to turn off the high voltage.
- 6. Clear the PPROG register to reconfigure the EEPROM address and data buses for normal operation.

\$103B

PPROG — EEPROM Programming Control

	Bit 7	6	5	4	3	2	1	Bit 0
	ODD	EVEN	0	BYTE	ROW	ERASE	EELAT	EEPGM
RESET:	0	0	0	0	0	0	0	0

- ODD Program Odd Rows in Half of EEPROM (TEST)
- EVEN Program Even Rows in Half of EEPROM (TEST)

BYTE — Byte/Other EEPROM Erase Mode

- The BYTE bit overrides the ROW bit.
 - 0 = Row or bulk erase mode is used
 - 1 = Erase only one byte of EEPROM

ROW — Row/All EEPROM Erase Mode

- The ROW bit is only valid when BYTE = 0.
 - 0 = All 512 bytes of EEPROM are erased
 - 1 = Erase only one 16-byte row of EEPROM

BYTE	ROW	Action
0	0	Bulk Erase (All 512 Bytes)
0	1	Row Erase (16 Bytes)
1	0	Byte Erase
1	1	Byte Erase

ERASE — Erase/Normal Control for EEPROM

- 0 = Normal read or program mode
- 1 = Erase mode

EELAT — EEPROM Latch Control

- 0 = EEPROM address and data bus configured for normal reads
- 1 = EEPROM address and data bus configured for programming or erasing

EEPGM — EEPROM Program Command

- 0 = Programming or erase voltage switched off to EEPROM array
- 1 = Programming or erase voltage switched on to EEPROM array

CONFIG — COP, ROM, EEPROM Enables									
	Bit 7	6	5	4	3	2	1	Bit 0	
	0	0	0	0	NOSEC	NOCOP	ROMON	FEON	

	0	0	0	0	NOSEC	NOCOP	ROMON	EEON
RESET:	0	0	0	0	_	_	—	_

NOTE

The bits of this register are implemented with EEPROM cells. Programming and erasing follow normal EEPROM procedures. The erased state of CONFIG is \$0F. A new value is not readable until after a subsequent reset sequence. CONFIG can only be programmed or erased in special modes.

NOSEC — EEPROM Security Disable

NOSEC has no meaning unless the security mask option was specified before the MCU was manufactured.

- 0 = Security enabled (available as a mask option on MC68HC11A8 only)
- 1 = Security disabled
- NOCOP COP system disable

Refer to 3 Resets and Interrupts.

ROMON — ROM Enable

Refer to 2 Operating Modes and Memory Maps.

- EEON EEPROM Enable
 - 0 = EEPROM is removed from the memory map
 - 1 = EEPROM is present in the memory map

5 Parallel Input/Output

The MC68HC11A8 has up to 38 input/output lines, depending on the operating mode. Port A has three input-only pins, four output-only pins, and one bidirectional I/O pin. Port A shares functions with the timer system.

Port B is an 8-bit output-only port in single-chip modes and is the high-order address in expanded modes.

Port C is an 8-bit bidirectional port in single-chip modes and the multiplexed address and data bus in expanded modes.

Port D is a 6-bit bidirectional port that shares functions with the serial systems.

Port E is an 8-bit input-only port that shares functions with the A/D system.

Simple and full handshake input and output functions are available on ports B and C lines in single-chip mode. A description of the handshake functions follows.

In port B simple strobed output mode, the STRB output is pulsed for two E-clock periods each time there is a write to the PORTB register. The INVB bit in the PIOC register controls the polarity of STRB pulses.

In port C simple strobed input mode, port C levels are latched into the alternate port C latch (PORTCL) register on each assertion of the STRA input. STRA edge select, flag and interrupt enable bits are located in the PIOC register. Any or all of the port C lines can still be used as general purpose I/O while in strobed input mode.

Port C full handshake mode involves port C pins and the STRA and STRB lines. Input and output handshake modes are supported, and output handshake mode has a three-stated variation. STRA is an edge detecting input, and STRB is a handshake output. Control and enable bits are located in the PIOC register.

In full input handshake mode, the MCU uses STRB as a "ready" line to an external system. Port C logic levels are latched into PORTCL when the STRA line is asserted by the external system. The MCU then negates STRB. The MCU reasserts STRB after the PORTCL register is read. A mix of latched inputs, static inputs, and static outputs is allowed on port C, differentiated by the data direction bits and use of the PORTCL and PORTCL registers.

In full output handshake mode, the MCU writes data to PORTCL, which in turn asserts the STRB output to indicate that data is ready. The external system reads port C (the STRB output) and asserts the STRA input to acknowledge that data has been received.

In the three-state variation of output handshake mode, lines intended as three-state handshake outputs are configured as inputs by clearing the corresponding DDRC bits. The MCU writes data to PORTCL and asserts STRB. The external system responds by activating the STRA input, which forces the MCU to drive the data in PORTCL out on all of the port C lines. This mode variation does not allow part of port C to be used for static inputs while other port C pins are being used for handshake outputs. Refer to the PIOC register description.

PORTA -	– Port A [Data						\$1000		
	Bit 7	6	5	4	3	2	1	Bit 0		
	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0]	
RESET:	HiZ	0	0	0	0	HiZ	HiZ	HiZ	L	
Alt. Pin Func.:	PAI	OC2	OC3	OC4	OC5	IC1	IC2	IC3		
And/or:	OC1	OC1	OC1	OC1	OC1	_	_	—		
PIOC — Parallel I/O Control \$1002										
	Bit 7	6	5	4	3	2	1	Bit 0		
	STAF	STAI	CWOM	HNDS	OIN	PLS	EGA	INVB]	
RESET:	0	0	0	0	0	U	1	1	1	
STAI — S 0 1 CWOM — 0 1 HNDS — 0	Strobe A II = STAF i = STAF i - Port C V = Port C = Port C Handsha = Simple	nterrupt E nterrupts Nire-OR M outputs a outputs a ke Mode strobe mo		sk cts all eigl CMOS ou rain outpu	ht port C r itputs ts				lshake mode)	
OIN — O HNDS 0	utput or Ir S must be = Input h	put Hand	shake Sel e for this k	lect						
 PLS — Pulse/Interlocked Handshake Operation HNDS must be set to one for this bit to have meaning. 0 = Interlocked handshake 1 = Pulsed handshake (strobe B pulses high for two E-clock cycles) 										
	= STRA f	alling edg	be A je selecteo e selecteo							

INVB — Invert Strobe B

- 0 = Active level is logic zero 1 = Active level is logic one

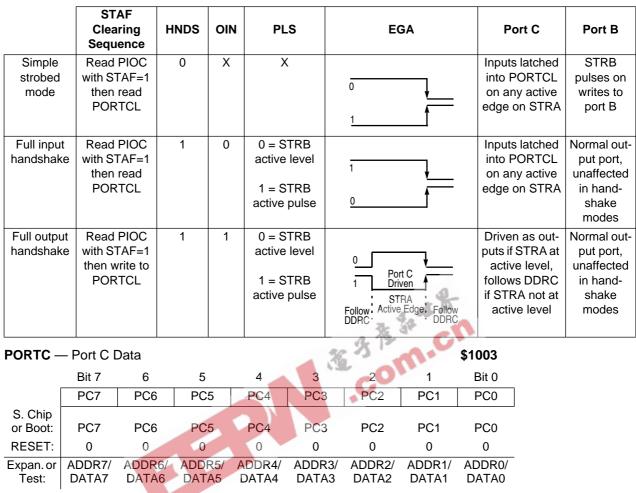


Table 5 Parallel I/O Control

NOTE

In single chip and boot modes, port C pins reset to high impedance inputs (DDRC registers are set to zero). In expanded and special test modes, port C is a multiplexed address/data bus and the port C register address is treated as an external memory location.

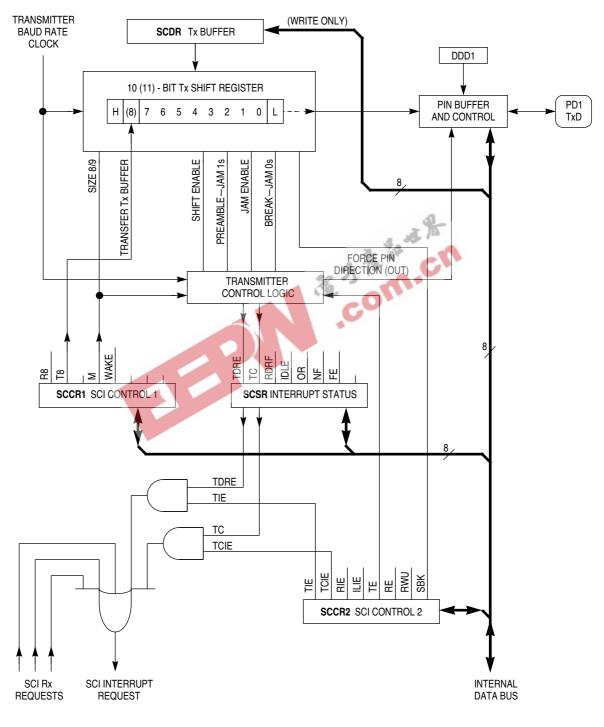
PORTB -	PORTB — Port B Data\$1004												
	Bit 7	6	5	4	3	2	1	Bit 0					
	PB7	PB6	PB5	PB4	PB3	PB2	PB1	PB0					
S. Chip or Boot:	PB7	PB6	PB5	PB4	PB3	PB2	PB1	PB0					
RESET:	0	0	0	0	0	0	0	0					
Expan.or Test:	ADDR15	ADDR14	ADDR13	ADDR12	ADDR11	ADDR10	ADDR9	ADDR8					
PORTCL	— Port C	Latched						\$1005					
	Bit 7	6	5	4	3	2	1	Bit 0					
	PCL7	PCL6	PCL5	PCL4	PCL3	PCL2	PCL1	PCL0					
RESET:	U	U	U	U	U	U	U	U					
		· • ·	DODTO										

Writes affect port C pins. PORTCL is used in the handshake clearing mechanism. When an active edge occurs on the STRA pin, port C data is latched into the PORTCL register.

DDRC — Data Direction Register for Port C \$1007															
	Bit 7	6	5	4	3	2	1	Bit 0							
	DDC7	DDC6	DDC5	DDC4	DDC3	DDC2	DDC1	DDC0							
RESET:	0	0	0	0	0	0	0	0							
0	— Data D = Input = Output	Direction F	Register fo	or Port C											
PORTD -	– Port D D	Data						\$1008							
	Bit 7	6	5	4	3	2	1	Bit 0							
	0	0	PD5	PD4	PD3	PD2	PD1	PD0							
RESET:	0	0	0	0	0	0	0	0							
Alt. Pin Func.:	_	_	SS	SCK	MOSI	MISO	TxD	RxD							
DDRD —	Data Dire	ection Reg	gister for F	Port D				\$1009							
	Bit 7	6	5	4	3	2	1.0	Bit 0							
	0	0	DDD5	DDD4	DDD3	DDD2	DDD1	DDD0							
RESET:	0	0	0	0	0	0	0	0							
Alt. Pin Func.:	—	—	PD5/ SS	PD4/ SCK	PD3/ MOSI	PD2/ MISO	PD1/ TxD	PD0/ RxD							
0	= Input	Direction f	or Port D	5)	DDD[5:0] — Data Direction for Port D 0 = Input 1 = Output										
PORTE — Port E Data \$100A															
PORTE -	– Port E D	Data						\$100A							
PORTE -	- Port E D Bit 7	Data 6	5	4	3	2	1	\$100A Bit 0							
	Bit 7 PE7	6 PE6	PE5	PE4	PE3	PE2	PE1	Bit 0 PE0							
RESET:	Bit 7	6						Bit 0							
	Bit 7 PE7	6 PE6	PE5	PE4	PE3	PE2	PE1	Bit 0 PE0							
RESET: Alt. Pin Func.:	Bit 7 PE7 U	6 PE6 U AN6	PE5 U AN5	PE4 U	PE3 U	PE2 U	PE1 U	Bit 0 PE0 U							
RESET: Alt. Pin Func.:	Bit 7 PE7 U AN7	6 PE6 U AN6	PE5 U AN5	PE4 U	PE3 U	PE2 U	PE1 U	Bit 0 PE0 U AN0							
RESET: Alt. Pin Func.:	Bit 7 PE7 U AN7 – Pulse Ad	6 PE6 U AN6	PE5 U AN5 or Control	PE4 U AN4	PE3 U AN3	PE2 U AN2	PE1 U AN1	Bit 0 PE0 U AN0 \$1026							
RESET: Alt. Pin Func.:	Bit 7 PE7 U AN7 – Pulse Ac Bit 7	6 PE6 U AN6 ccumulato 6	PE5 U AN5 or Control 5	PE4 U AN4 4	PE3 U AN3 3	PE2 U AN2 2	PE1 U AN1	Bit 0 PE0 U AN0 \$1026 Bit 0							
RESET: Alt. Pin Func.: PACTL – RESET: DDRA7 – 0	Bit 7 PE7 U AN7 – Pulse Ac Bit 7 DDRA7	6 PE6 U AN6 ccumulato 6 PAEN 0	PE5 U AN5 or Control 5 PAMOD 0	PE4 U AN4 4 PEDGE 0	PE3 U AN3 3 0	PE2 U AN2 2 0	PE1 U AN1 1 RTR1	Bit 0 PE0 U AN0 \$1026 Bit 0 RTR0							
RESET: Alt. Pin Func.: PACTL – RESET: DDRA7 – 0 1 PAEN —	Bit 7 PE7 U AN7 – Pulse Ac Bit 7 DDRA7 0 – Data Dir = Input	6 PE6 U AN6 ccumulato 6 PAEN 0 rection for	PE5 U AN5 or Control 5 PAMOD 0 Port A Bi System E	PE4 U AN4 4 PEDGE 0 t 7	PE3 U AN3 3 0	PE2 U AN2 2 0	PE1 U AN1 1 RTR1	Bit 0 PE0 U AN0 \$1026 Bit 0 RTR0							
RESET: Alt. Pin Func.: PACTL – RESET: DDRA7 – 0 1 PAEN – Refer PAMOD –	Bit 7 PE7 U AN7 - Pulse Ac Bit 7 DDRA7 0 - Data Dir = Input = Output Pulse Acc	6 PE6 U AN6 ccumulato 6 PAEN 0 rection for cumulator e Accum	PE5 U AN5 or Control 5 PAMOD 0 Port A Bi System E aulator.	PE4 U AN4 4 PEDGE 0 t 7	PE3 U AN3 3 0	PE2 U AN2 2 0	PE1 U AN1 1 RTR1	Bit 0 PE0 U AN0 \$1026 Bit 0 RTR0							
RESET: Alt. Pin Func.: PACTL – RESET: DDRA7 – 0 1 PAEN – Refer PAMOD – Refer PEDGE –	Bit 7 PE7 U AN7 – Pulse Ac Bit 7 DDRA7 0 – Data Dir = Input = Output Pulse Acc r to 9 Puls	6 PE6 U AN6 ccumulato 6 PAEN 0 rection for cumulator e Accum	PE5 U AN5 or Control 5 PAMOD 0 Port A Bi System E aulator. for Mode aulator. for Edge C	PE4 U AN4 4 PEDGE 0 t 7	PE3 U AN3 3 0	PE2 U AN2 2 0	PE1 U AN1 1 RTR1	Bit 0 PE0 U AN0 \$1026 Bit 0 RTR0							

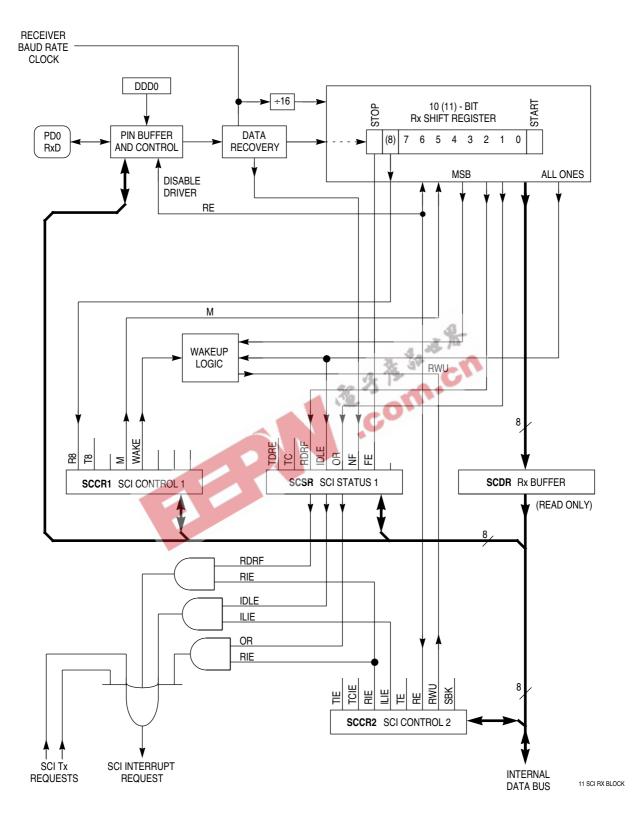
6 Serial Communications Interface (SCI)

The SCI, a universal asynchronous receiver transmitter (UART) serial communications interface, is one of two independent serial I/O subsystems in the MC68HC11A8. It has a standard NRZ format (one start, eight or nine data, and one stop bit) and several baud rates available. The SCI transmitter and receiver are independent, but use the same data format and bit rate.

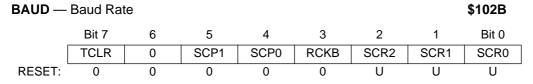


11 SCI TX BLOCK









TCLR — Clear Baud Rate Counters (TEST)

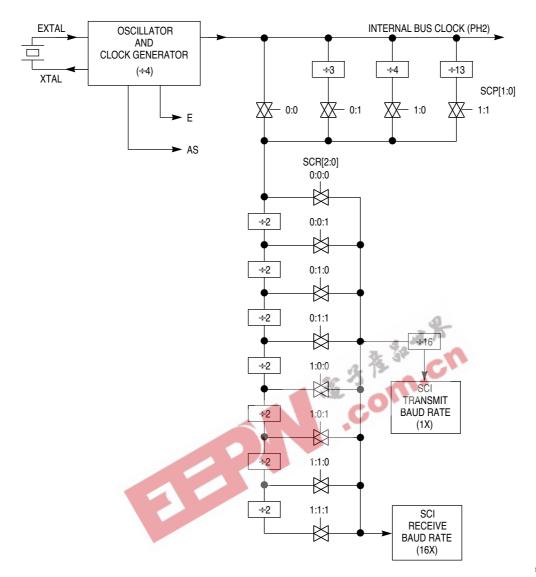
SCP1, SCP0 — SCI Baud Rate Prescaler Selects

	Divide	Crystal Frequency in MHz						
SCP[1:0]	Internal Clock By	4.0 MHz (Baud)	8.0 MHz (Baud)	10.0 MHz (Baud)	12.0 MHz (Baud)			
00	1	62.50K	125.0K	156.25K	187.5K			
01	3	20.83K	41.67K	52.08K	62.5K			
10	4	15.625K	31.25K	38.4K	46.88K			
11	13	4800	9600	12.02K	14.42K			

RCKB — SCI Baud Rate Clock Check (TEST)

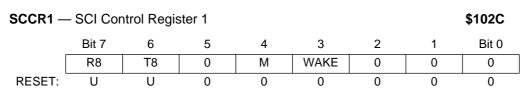
34 × 8-SCR2, SCR1, and SCR0 - SCI Baud Rate Selects Selects receiver and transmitter bit rate based on output from baud rate prescaler stage. **R**2

SCP[2:0]	Divide Prescaler	Highest Baud Rate (Prescaler Output from Previous Table)					
	Ву	4800	9600	38.4K			
000	1	4800	9600	38.4K			
001	2	2400	4800	19.2K			
010	4	1200	2400	9600			
011	8	600	1200	4800			
100	16	300	600	2400			
101	32	150	300	1200			
110	64	—	150	600			
111	128		—	300			



SCI BAUD GENERATOR

Figure 8 SCI Baud Rate Diagram



R8 — Receive Data Bit 8

If M bit is set, R8 stores ninth bit in receive data character.

T8 — Transmit Data Bit 8

If M bit is set, T8 stores ninth bit in transmit data character.

M — Mode (Select Character Format)

0 = Start bit, 8 data bits, 1 stop bit

1 = Start bit, 9 data bits, 1 stop bit

WAKE — Wake Up by Address Mark/Idle

0 = Wake up by IDLE line recognition

1 = Wake up by address mark (most significant data bit set)

SCCR2 — SCI Control Register 2 \$102D								
	Bit 7	6	5	4	3	2	1	Bit 0
Γ	TIE	TCIE	RIE	ILIE	TE	RE	RWU	SBK
RESET:	0	0	0	0	0	0	0	0
	= TDRE i	errupt Ena nterrupts (errupt requ	disabled	nen TDRE	status fla	ig is set		
	= TC inte	complete I rrupts disa errupt requ	abled		o one			
1.	= RDRF a	and OR in	terrupts d		flag or th	e OR stat	tus flag is	set
ILIE — Idle 0 : 1 :	e Line Int = IDLE in = SCI inte	errupt Ena terrupts d errupt requ	able isabled uested wh	nen IDLE s	status flag	is set	State In	2
TE — Trar 0 : 1 :	nsmitter E = Transm = Transm	errupt Ena terrupts d errupt requ Enable hitter disab	led led	1		.co		
RE — Rec 0 :	eiver Ena = Receive	able er disableo er enableo	d					
	= Normal	Vake Up (SCI recei ip enablec	ver	eiver inter	rupts inhit	bited		
	= Break g	k generator (codes gen		long as S	BK is set	to one		
SCSR —	SCI Statu	s Registe	r					\$102E
	Bit 7	6	5	4	3	2	1	Bit 0
				IDLE				
RESET:	TDRE 1	TC 1	RDRF 0		OR 0	NF 0	FE 0	0

TDRE — Transmit Data Register Empty Flag

Set if transmit data can be written to SCDR; if TDRE is zero, transmit data register is busy. Cleared by SCSR read with TDRE set followed by SCDR write.

TC — Transmit Complete Flag

Set if transmitter is idle (no data, preamble, or break transmission in progress). Cleared by SCSR read with TC set followed by SCDR write.

RDRF — Receive Data Register Full Flag

Set if a received character is ready to be read from SCDR. Cleared by SCSR read with RDRF set followed by SCDR read.

IDLE — Idle Line Detected Flag

Set if the RxD line is idle. IDLE flag is inhibited when RWU is set to one. Cleared by SCSR read with IDLE set followed by SCDR read. Once cleared, IDLE is not set again until the RxD line has been active and becomes idle again.

OR — Overrun Error Flag

Set if a new character is received before a previously received character is read from SCDR. Cleared by SCSR read with OR set followed by SCDR read.

NF — Noise Error Flag

Set if majority sample logic detects anything other than a unanimous decision. Cleared by SCSR read with NF set followed by SCDR read.

FE — Framing Error

Set if a zero is detected where a stop bit was expected. Cleared by SCSR read with FE set followed by SCDR read.

SCDR — SCI Data Register \$102F Bit 7 6 5 4 3 Bit 0 R7/T7 R6/T6 R5/T5 R4/T4 R3/T3 R0/T0 R1/T1 RESET: U U U U U U NOTE

Receive and transmit are double buffered. Reads access the receive data buffer and writes access the transmit data buffer.

7 Serial Peripheral Interface (SPI)

The SPI is one of two independent serial communications subsystems that allow the MCU to communicate synchronously with peripheral devices and other microprocessors. Data rates can be as high as one half of the E-clock rate when configured as master, and as fast as the E clock when configured as slave.

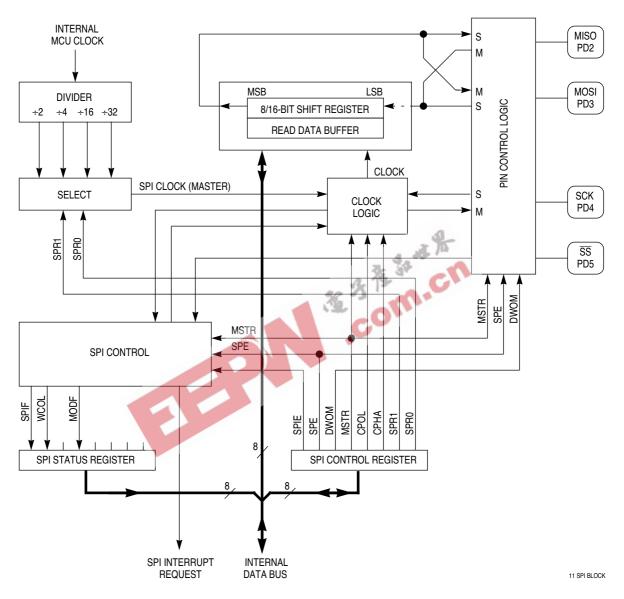


Figure 9 SPI Block Diagram

DDRD — Data Direction Register for Port D									
	Bit 7	6	5	4	3	2	1	Bit 0	
	0	0	DDD5	DDD4	DDD3	DDD2	DDD1	DDD0	
RESET:	0	0	0	0	0	0	0	0	
Alt. Pin Func.:			PD5/ SS	PD4/ SCK	PD3/ MOSI	PD2/ MISO	PD1/ TxD	PD0/ RxD	

DDD[5:0] — Data Direction for Port D

When DDRD bit 5 is zero and MSTR = 1 in SPCR, PD5/ \overline{SS} is a general-purpose output and mode fault logic is disabled.

\$1028

- 0 = Input
- 1 = Output
- SPCR Serial Peripheral Control Register

6 5 3 Bit 7 4 2 1 Bit 0 SPIE SPE DWOM MSTR CPOL CPHA SPR1 SPR0 RESET: 0 0 U U 0 0 0 1 SPIE — Serial Peripheral Interrupt Enable 0 = SPI interrupts disabled 1 = SPI interrupts enabled SPE — Serial Peripheral System Enable 0 = SPI off1 = SPI onDWOM - Port D Wired-OR Mode ·Com.cn DWOM affects all six port D pins. 0 = Normal CMOS outputs 1 = Open-drain outputs MSTR — Master Mode Select 0 = Slave mode 1 = Master mode CPOL, CPHA - Clock Polarity, Clock Phase Refer to Figure 10 SCK CYCLE # 3 4 5 7 2 6 8 SCK (CPOL = 0) SCK (CPOL = 1) SAMPLE INPUT MSB 2 I SB 6 5 4 3 (CPHA = 0) DATA OUT SAMPLE INPUT MSB LSB 6 5 4 3 2 (CPHA = 1) DATA OUT SS (TO SLAVE) SLAVE CPHA=1 TRANSFER IN PROGRESS (3) MASTER TRANSFER IN PROGRESS 4 (2) SLAVE CPHA=0 TRANSFER IN PROGRESS (5) (1)1. SS ASSERTED 2. MASTER WRITES TO SPDR 3. FIRST SCK EDGE 4. SPIF SET 5. SS NEGATED





SPR1 and SPR0 - SPI Clock Rate Selects

SPR [1:0]	E-Clock Divide By	Frequency at E = 2 MHz (Baud)
00	2	1.0 MHz
01	4	500 kHz
10	16	125 kHz
11	32	62.5 kHz

${\sf SPSR}$ —	Serial Pe	ripheral St	tatus Reg	\$1029							
	Bit 7	6	5	4	3	2	1	Bit 0			
	SPIF	WCOL	0	MODF	0	0	0	0			
RESET:	0	0	0	0	0	0	0	0	1		
	SPIF — SPI Transfer Complete Flag Set when an SPI transfer is complete. Cleared by reading SPSR with SPIF set followed by SPDR										

R access.

WCOL — Write Collision

Set when SPDR is written while transfer is in progress. Cleared by SPSR with WCOL set followed by SPDR access.

MODF — Mode Fault (A Mode Fault Terminates SPI Operation) Set when SS is pulled low while MSTR = 1. Cleared by SPSR read with MODF set followed by SPCR write.

SPDR — SPI Data Register \$102A										
	Bit 7	6	5	4	3	2	1	Bit 0		
[Bit 7	6	5	4	3	2	1	Bit 0		
NOTE										
	SP	I is double	buffered	in, single	buffered	out.				

8 Main Timer

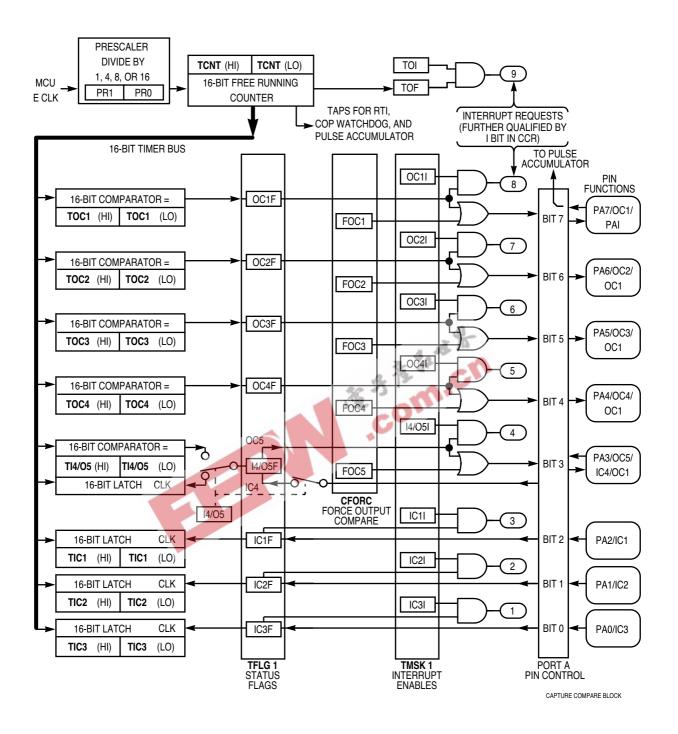
The main timer is based on a free-running 16-bit counter with a four-stage programmable prescaler. A timer overflow function allows software to extend the system's timing capability beyond the counter's 16-bit range.

The timer has three channels of input capture and five channels of output compare.

Refer to the following table for a summary of crystal-related frequencies and periods.

	XTAL Frequencies									
Control	4.0 MHz	8.0 MHz	12.0 MHz	Other Rates						
Bits	1.0 MHz	2.0 MHz	3.0 MHz	(E)						
	1000 ns	500 ns	333 ns	(1/E)						
PR[1:0]		Main Timer	Count Rates							
0 0										
1 count —	1.0 μs	500 ns	333 ns	(E/1)						
overflow —	65.536 ms	32.768 ms	21.845 ms	(E/2 ¹⁶)						
0 1			3 15							
1 count —	4.0 μs	2.0 μs	1.333 μs	(E/4)						
overflow —	262.14 ms	131.07 ms 🔔	87.381 ms	(E/2 ¹⁸)						
10		18 3								
1 count —	8.0 μs	4.0 μs	2.667 μs	(E/8)						
overflow —	524.29 ms	262.14 ms	174.76 ms	(E/2 ¹⁹)						
11										
1 count —	16.0 μs	8.0 µs	5.333 µs	(E/16)						
overflow —	1.049 s	524.29 ms	349.52 ms	(E/2 ²⁰)						
RTR[1:0]		Periodic (RTI)	Interrupt Rates							
00	8.192 ms	4.096 ms	2.731 ms	(E/2 ¹³)						
0 1	16.384 ms	8.192 ms	5.461 ms	(E/2 ¹⁴)						
10	32.768 ms	16.384 ms	10.923 ms	(E/2 ¹⁵)						
11	65.536 ms	32.768 ms	21.845 ms	· · ·						
				(E/2 ¹⁶)						

Table 6 Timer Summary





NOTE: Port A pin actions are controlled by OC1M, OC1D, PACTL, TCTL1, and TCTL2 registers.

CFORC — Timer Compare Force \$100B										
	Bit 7	6	5	4	3	2	1	Bit	D	
	FOC1	FOC2	FOC3	FOC4	FOC5	0	0	0		
RESET:	0	0	0	0	0	0	0	0		
FOC5–FOC1 — Write ones to Force Compare(s) 0 = Not affected 1 = Output compare x action occurs, but OCxF flag bit not set										
OC1M —	- Output C	ompare 1	Mask					\$1000	C	
	Bit 7	6	5	4	3	2	1	Bit	0	
	OC1M7	OC1M6	OC1M5	OC1M4	OC1M3	0	0	0		
RESET:	0	0	0	0	0	0	0	0		
Set b	it(s) to ena	able OC1 t	o control o	correspon	ding pin(s	s) of port	A.			
0C1D —	OC1D — Output Compare 1 Data \$100D									
	Bit 7	6	5	4	3	2	1	Bit	D	
	OC1D7	OC1D6	OC1D5	OC1D4	OC1D3	0	0	0		
RESET:	0	0	0	0	0	0	0	0		
If OC	1Mx is set	t, data in C	C1Dx is c	output to p	ort A bit x	on succ	essful	OC1 com	pares.	
TCNT —	Timer Co	unter				co	1	\$100	E, \$100F	
\$100E	Bit 15	14	13	12	11	10	9	Bit 8	5	TCNT
	Bit 7	6	5	4	3	2	1	Bit	0 Low	
TCN	T resets to	\$0000. In	normal m	odes, TCI	VT is read	d-only.				
TIC1-TIC	3 — Timei	Input Cap	oture					\$1010	-\$1015	
\$ 1 010	Bit 15	14	13	12	11	1	0	9	Bit 8	High TIC1
\$ 1 011	Bit 7	6	5	4	3	2	2	1	Bit 0	Low
\$ 1 012	Bit 15	14	13	12	11	1	0	9	Bit 8	High TIC2
\$ 1 013	Bit 7	6	5	4	3	2	2	1	Bit 0	Low
\$ 1 014	Bit 15	14	13	12	11	1	0	9	Bit 8	High TIC3
\$ 1 015	Bit 7	6	5	4	3	2	2	1	Bit 0	Low

TICx not affected by reset.

TOC1–TOC5 — Timer Output Compare

\$1016-\$101F

		lei Output	compare					φισιο	φιστι		
\$ 1 016	Bit 15	14	13	12	11	1	0	9	Bit 8	High	TOC1
\$ 1 017	Bit 7	6	5	4	3	2	2	1	Bit 0	Low	
\$ 1 018	Bit 15	14	13	12	11	1	0	9	Bit 8	High	TOC2
\$ 1 019	Bit 7	6	5	4	3	2	2	1	Bit 0	Low	
\$ 1 01A	Bit 15	14	13	12	11	1	0	9	Bit 8	High	тосз
\$ 1 01B	Bit 7	6	5	4	3	2	2	1	Bit 0	Low	
\$ 1 01C	Bit 15	14	13	12	11	1	0	9	Bit 8	High	TOC4
\$ 1 01D	Bit 7	6	5	4	3	2	2	1	Bit 0	Low	
\$ 1 01E	Bit 15	14	13	12	11	1	0	9	Bit 8	High	TOC5
\$ 1 01F	Bit 7	6	5	4	3	2	2	1	Bit 0	Low	
All To	OCx regist	er pairs re	set to ones	s (\$FFFF).							
TCTL1 — Timer Control 1 \$1020											
	Bit 7	6	5	4	3	2	1 🚜	Bit ()		
	OM2	OL2	OM3	OL3	OM4	OL4	OM5	OLS	5		
RESET:	0	0	0	0	0	0	0	0			
OM2-ON	/15 — Outp	out Mode			26	スト	A				
	5 — Outpu	it Loval				2 OL4					
	o Ouipe										
		ОМх	OLx			en on Su		-	e		
		0	0			cted from	output pin	logic			
		0	1		OCx out	-					
		1	0		-	ut line to 0					
		1	1	Set OC	x output	line to 1					
TCTL2 –	– Timer Co	ontrol 2						\$1021			
	Bit 7	6	5	4	3	2	1	Bit ()		
	—	—	EDG1B	EDG1A E	DG2B	EDG2A	EDG3B	EDG	3A		
RESET:	0	0	0	0	0	0	0	0			
			Table	7 Timer C	ontrol (Configur	ation				
			-								

EDGxB	EDGxA	Configuration
0	0	Capture disabled
0	1	Capture on rising edges only
1	0	Capture on falling edges only
1	1	Capture on any edge

TMSK1 -	– Timer In	\$1022						
	Bit 7	6	5	4	3	2	1	Bit 0
	OC1I	OC2I	OC3I	OC4I	OC5I	IC1I	IC2I	IC3I
	0 5I — Outj OCxI ena					0 set, a haro	0 dware inte	0 errupt seq
	I — Input (ICxI enab	•	•		ag bit is se	et, a hardw	vare interr	upt seque
NOTE Bits in TMSK1 correspond bit for bit with flag bits in TFLG1. Ones in TMSK1 enable the corresponding interrupt sources.								
TFLG1 –	- Timer Int	terrupt Fla	g 1					\$1023
	Bit 7	6	5	4	3	2	1	Bit 0
05055	OC1F	OC2F	OC3F	OC4F	OC5F	IC1F	IC2F	IC3F
RESET:	0 flags by v	0	0	0	0	0	e c	0
Set e	BF — Input ach time a – Timer In	aselected	active ed	ige is dete	ected on th	ne ICx inp		\$1024
	Bit 7	6	5	4	3	2	1	Bit 0
	TOI	RTII	PAOVI	PAII	0	0	PR1	PR0
RESET:	0	0	0	0	0	0	0	0
C 1 RTII — R	mer Overf = TOF int = Interrup eal-Time I	terrupts di ot requeste Interrupt E	sabled ed when ⁻ nable		t to one			
	= RTIF in = Interrup			RTIF is se	t to one			
	- Pulse Ac to 9 Puls			/ Interrupt	Enable			
	ulse Accu r to 9 Puls			Interrupt	Enable			
					NOTE			
		s in TMSK correspo				ag bits in T	FLG2. Or	nes in TM
In no	PR0 — Ti rmal mode . Refer to	es, PR1 ar	nd PR0 ca	an only be		nce, and t	he write n	nust be w

PR[1:0]	Prescaler
0 0	1
0 1	4
10	8
11	16

TFLG2 — Timer Interrupt Flag 2

\$1025

	Bit 7	6	5	4	3	2	1	Bit 0
	TOF	RTIF	PAOVF	PAIF	0	0	0	0
RESET:	0	0	0	0	0	0	0	0

Clear flags by writing a one to the corresponding bit position(s).

- TOF Timer Overflow Flag
 - Set when TCNT changes from \$FFFF to \$0000.
- RTIF Real-Time (Periodic) Interrupt Flag Set periodically. Refer to RTR[1:0] bits in PACTL register.
- PAOVF Pulse Accumulator Overflow Interrupt Flag Refer to 9 Pulse Accumulator.
- PAIF Pulse Accumulator Input Edge Interrupt Flag Refer to 9 Pulse Accumulator.
- PACTL Pulse Accumulator Control

Set p	Set periodically. Refer to RTR[1:0] bits in PACTL register.											
PAOVF — Pulse Accumulator Overflow Interrupt Flag Refer to 9 Pulse Accumulator .												
PAIF — Pulse Accumulator Input Edge Interrupt Flag Refer to 9 Pulse Accumulator .												
PACTL -	– Pulse Ad	ccumulato	r Control					\$1026				
	Bit 7	6	5	4)	3	2	1	Bit 0				
	DDRA7	PAEN	PAMOD	PEDGE	0	0	RTR1	RTR0				
RESET:	0	0	0	0	0	0	0	0				

- DDRA7 Data Direction for Port A Bit 7 Refer to 5 Parallel Input/Output.
- PAEN Pulse Accumulator Enable Refer to 9 Pulse Accumulator.
- PAMOD Pulse Accumulator Mode Select Refer to 9 Pulse Accumulator.
- PEDGE Pulse Accumulator Edge Select Refer to 9 Pulse Accumulator.
- RTR [1:0] Real-Time Interrupt (RTI) Rate

RTR[1:0]	Divide E By	XTAL = 4.0 MHz	XTAL = 8.0 MHz	XTAL = 12.0 MHz
0 0	2 ¹³	8.19 ms	4.096 ms	2.731 ms
0 1	2 ¹⁴	16.38 ms	8.192 ms	5.461 ms
1 0	2 ¹⁵	32.77 ms	16.384 ms	10.923 ms
1 1	2 ¹⁶	65.54 ms	32.768 ms	21.845 ms
	E =	1.0 MHz	2.0 MHz	3.0 MHz

9 Pulse Accumulator

The MC68HC11A8 has an 8-bit counter that can be configured to operate as a simple event counter or for gated time accumulation, depending on the PAMOD bit in the PACTL register. The pulse accumulator counter can be read or written at any time.

The port A bit 7 I/O pin can be configured as a clock in event counting mode, or as a gate signal to enable a free-running clock (E divided by 64) in gated time accumulation mode.

		Common XTAL Frequencies					
	Selected Crystal	4.0 MHz	8.0 MHz	12.0 MHz			
CPU Clock	(E)	1.0 MHz	2.0 MHz	3.0 MHz			
Cycle Time	(1/E)	1000 ns	500 ns	333 ns			
Pulse Accumulator (in (Gated Mode)						
(E/2 ⁶) (E/2 ¹⁴)	1 count — overflow —	64.0 μs 16.384 ms	32.0 μs 8.192 ms	21.33 μs 5.461 ms			

Table 9 Pulse Accumulator Timing

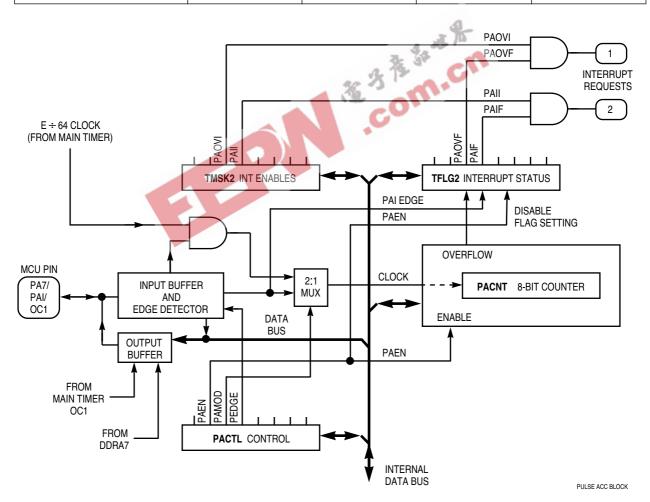
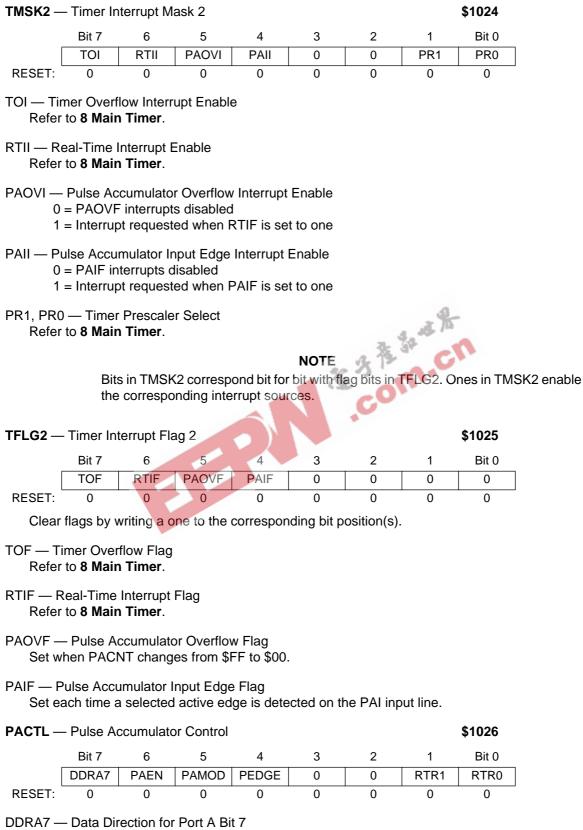


Figure 12 Pulse Accumulator System Block Diagram



Refer to 5 Parallel Input/Output.

PAEN — Pulse Accumulator System Enable

- 0 = Pulse Accumulator disabled
- 1 = Pulse Accumulator enabled
- PAMOD Pulse Accumulator Mode
 - 0 = Event counter
 - 1 = Gated time accumulation
- PEDGE Pulse Accumulator Edge Control

PAMOD	PEDGE	Action on Clock
0	0	PAI falling edge increments the counter
0	1	PAI rising edge increments the counter
1	0	A zero on PAI inhibits counting
1	1	A one on PAI inhibits counting

RTR1 and RTR0 — Real-Time Interrupt (RTI) Rate Refer to 8 Main Timer.

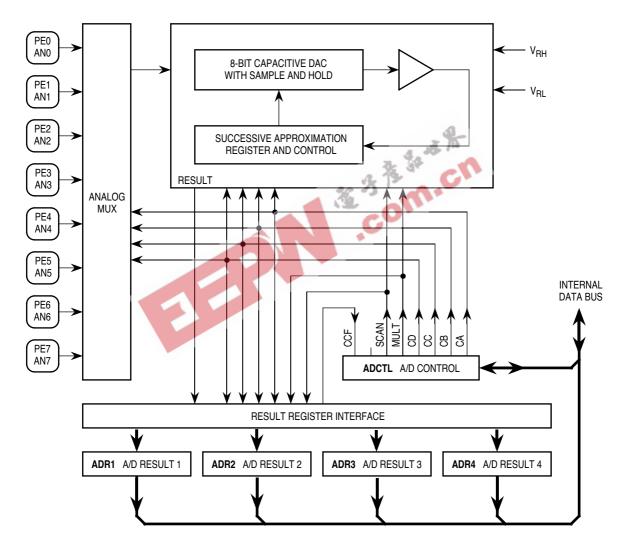


10 Analog-to-Digital Converter

The A/D converter system uses an all capacitive charge redistribution technique to convert analog signals to digital values. The MC68HC11A8 A/D system is an 8-channel, 8-bit, multiplexed-input, successive-approximation converter and is accurate to ± 1 least significant bit (LSB). It does not require external sample and hold circuits because of the type of charge redistribution technique used.

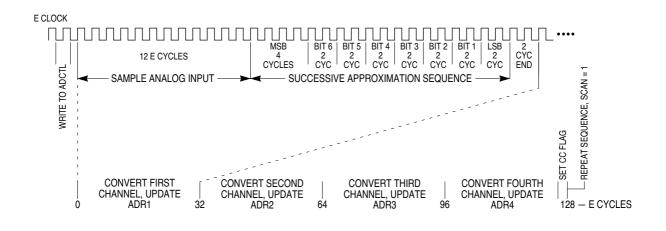
Dedicated lines V_{RH} and V_{RL} provide the reference supply voltage inputs. Refer to the A/D converter block diagram.

A multiplexer allows the single A/D converter to select one of 16 analog signals, as shown in the ADCTL register description.

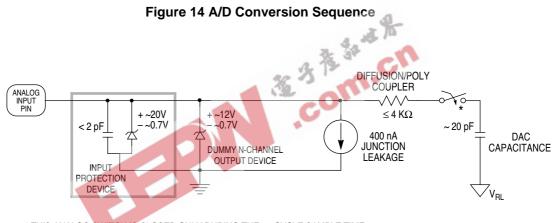


EA9 A/D BLOCK

Figure 13 A/D Converter Block Diagram



A/D CONVERSION TIM



* THIS ANALOG SWITCH IS CLOSED ONLY DURING THE 12-CYCLE SAMPLE TIME.

ANALOG INPUT PIN

Figure 15 Electrical Model of an Analog Input Pin (Sample Mode)

ADCTL — A/D Control/Status								\$1030
	Bit 7	6	5	4	3	2	1	Bit 0
	CCF	0	SCAN	MULT	CD	CC	СВ	CA
RESET:	U	0	U	U	U	U	U	U

CCF — Conversions Complete Flag

Set after an A/D conversion cycle. Cleared when ADCTL is written.

- SCAN Continuous Scan Control
 - 0 = Do four conversions and stop
 - 1 = Convert four channels in selected group continuously

MULT — Multiple Channel/Single Channel Control

- 0 = Convert single channel selected
- 1 = Convert four channels in selected group

CD-CA — Channel Select D through A

C	hannel Select	Control Bits	Channel	Result in ADRx if		
CD	CC	СВ	CA	Signal	MULT = 1	
0	0	0	0	AN0	ADR1	
0	0	0	1	AN1	ADR2	
0	0	1	0	AN2	ADR3	
0	0	1	1	AN3	ADR4	
0	1	0	0	AN4*	ADR1	
0	1	0	1	AN5*	ADR2	
0	1	1	0	AN6*	ADR3	
0	1	1	1	AN7*	ADR4	
1	0	Х	Х	Reserved	ADR1–ADR4	
1	1	0	0	V _{RH} **	ADR1	
1	1	0	1	V _{RL} **	ADR2	
1	1	1	0	(V _{RH})/2**	ADR3	
1	1	1	1	Reserved**	ADR4	

Table 10 A/D Converter Channel Assignments

	•			•	•	1.000	100		5111
* Not available in 48-pin package **Used for factory testing									
ADR1-A	DR4 — A/	D Results	;			° c0		\$1031–\$	1034
	Bit 7	6	5	4	3	2	1	Bit 0	
\$ 1 031	Bit 7	6	5	4)	3	2	1	Bit 0	ADR1
\$1 032	Bit 7	6	5	4	3	2	1	Bit 0	ADR2
\$1 033	Bit 7	6	5	4	3	2	1	Bit 0	ADR3
\$ 1 034	Bit 7	6	5	4	3	2	1	Bit 0	ADR4

Table 11 Analog Input to 8-Bit Result Translation Table

	Bit 7	6	5	4	3	2	1	Bit 0
% (1)	50%	25%	12.5%	6.25%	3.12%	1.56%	0.78%	0.39%
Volts ⁽²⁾	2.500	1.250	0.625	0.3125	0.1562	0.0781	0.0391	0.0195
⁽¹⁾ % of $V_{BH} - V_{BI}$ ⁽²⁾ $V_{BI} = 0.0 \text{ V}; V_{BH} = 5.0 \text{ V}$								

of V _{RH} –V _{RL}	$^{(2)}$ V _{RL} = 0.0 V; V _{RH} = 5.

OPTION — System Configuration Options								\$1039
	1	Bit 0						
	ADPU	CSEL	IRQE*	DLY*	CME	0	CR1*	CR0*
RESET:	0	0	0	1	0	0	0	0

*Can be written only once in first 64 cycles out of reset in normal modes, or any time in special modes.

ADPU — A/D Power Up

0 = A/D Converter powered down

1 = A/D Converter powered up

CSEL — Clock Select

0 = A/D and EEPROM use system E clock

1 = A/D and EEPROM use internal RC clock

MC68HC11A8 MC68HC11A8TS/D

- IRQE IRQ Select Edge Sensitive Only Refer to **3 Resets and Interrupts**.
- DLY Enable Oscillator Start-Up Delay on Exit from STOP Refer to **3 Resets and Interrupts**.
- CME Clock Monitor Enable Refer to **3 Resets and Interrupts**.
- CR1, CR0 COP Timer Rate Select Refer to **3 Resets and Interrupts**.





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MC68HC11A8TS/D

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